

Single P-channel MOSFET

ELM13415CA-S

■General description

ELM13415CA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance. Internal ESD protection is included.

■Features

- $V_{ds}=-20V$
- $I_d=-4A$ ($V_{gs}=-4.5V$)
- $R_{ds(on)} < 43m\Omega$ ($V_{gs}=-4.5V$)
- $R_{ds(on)} < 54m\Omega$ ($V_{gs}=-2.5V$)
- $R_{ds(on)} < 73m\Omega$ ($V_{gs}=-1.8V$)
- ESD protected

■Maximum absolute ratings

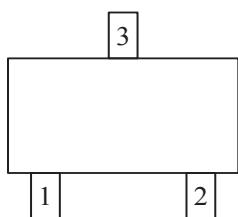
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	-20	V	
Gate-source voltage	V_{gs}	± 8	V	
Continuous drain current	I_d	-4.0	A	
		-3.5		
Pulsed drain current	I_{dm}	-30	A	3
Power dissipation	P_d	1.5	W	2
		1.0		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	65	80	°C/W	1
Maximum junction-to-ambient		85	100	°C/W	1, 4
Maximum junction-to-lead	$R_{\theta jl}$	43	52	°C/W	

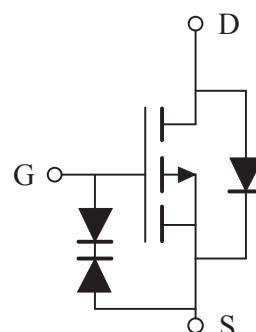
■Pin configuration

SOT-23(TOP VIEW)



Pin No.	Pin name
1	GATE
2	SOURCE
3	DRAIN

■Circuit



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■Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit	
STATIC PARAMETERS								
Drain-source breakdown voltage	BV _{dss}	Id=-250μA, V _{gs} =0V		-20			V	
Zero gate voltage drain current	Id _{ss}	V _{ds} =-20V	T _j =55°C			-1	μA	
		V _{gs} =0V				-5		
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±8V				±10	μA	
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , Id=-250μA		-0.30	-0.57	-0.90	V	
On state drain current	Id(on)	V _{gs} =-4.5V, V _{ds} =-5V		-30			A	
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =-4.5V	T _j =125°C		37	43	mΩ	
		Id=-4A			52	62		
		V _{gs} =-2.5V, Id=-4A			45	54		
		V _{gs} =-1.8V, Id=-2A			54	73		
		V _{gs} =-1.5V, Id=-1A			65			
Forward transconductance	G _{fs}	V _{ds} =-5V, Id=-4A			20		S	
Diode forward voltage	V _{sd}	Is=-1A, V _{gs} =0V			-0.64	-1.00	V	
Max. body-diode continuous current	I _s					-2	A	
DYNAMIC PARAMETERS								
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =-10V, f=1MHz		620	780	940	pF	
Output capacitance	C _{oss}			80	115	150	pF	
Reverse transfer capacitance	C _{rss}			50	80	110	pF	
SWITCHING PARAMETERS								
Total gate charge	Q _g	V _{gs} =-4.5V, V _{ds} =-10V Id=-4A		7.4	9.3	11.0	nC	
Gate-source charge	Q _{gs}			1.2	1.5	1.8	nC	
Gate-drain charge	Q _{gd}			1.0	1.8	2.5	nC	
Turn-on delay time	t _{d(on)}	V _{gs} =-4.5V, V _{ds} =-10V R _l =2.5Ω, R _{gen} =3Ω			120		ns	
Turn-on rise time	t _r				240		ns	
Turn-off delay time	t _{d(off)}				2.8		ns	
Turn-off fall time	t _f				2.0		ns	
Body diode reverse recovery time	t _{rr}	I _f =-4A, dI/dt=500A/μs		11	14	17	ns	
Body diode reverse recovery charge	Q _{rr}	I _f =-4A, dI/dt=500A/μs		24	30	36	nC	

NOTE :

- The value of R_{θja} is measured with the device mounted on 1in2 FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given application depends on the user's specific board design.
- The power dissipation P_d is based on T_j(Max)=150°C, using 10s junction-to-ambient thermal resistance.
- Repetitive rating, pulse width limited by junction temperature T_j(Max)=150°C. Ratings are based on low frequency and duty cycles to keep initial T_j=25°C.
- The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
- The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.
- These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in2 FR-4 board with 2oz.Copper, assuming a maximum junction temperature of T_j(Max)=150°C. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics

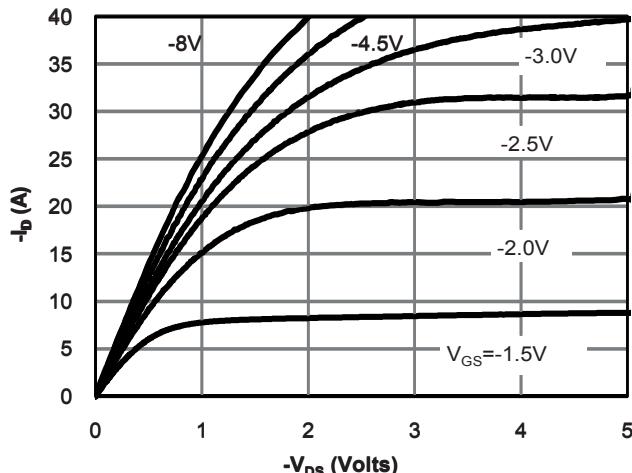


Fig 1: On-Region Characteristics (Note E)

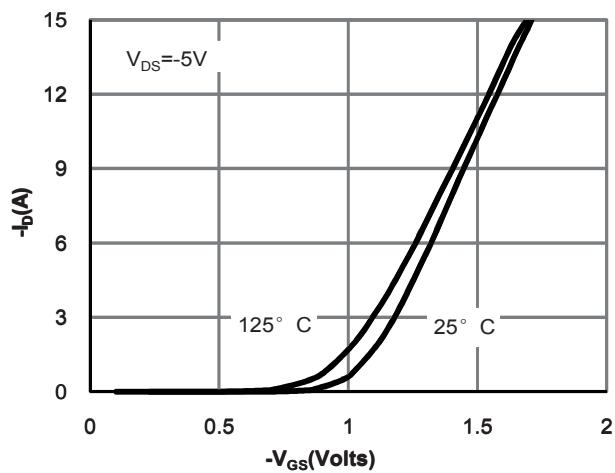


Figure 2: Transfer Characteristics (Note E)

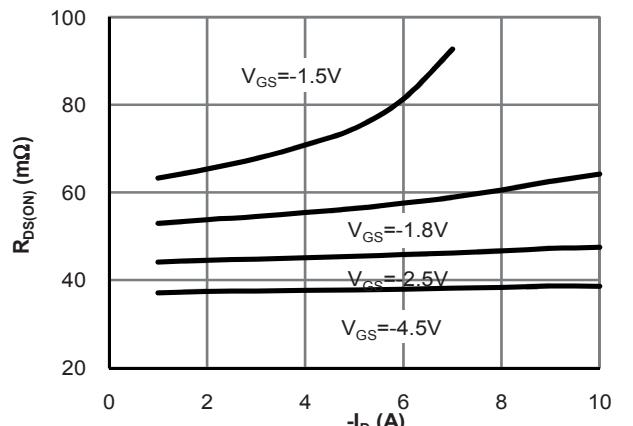


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

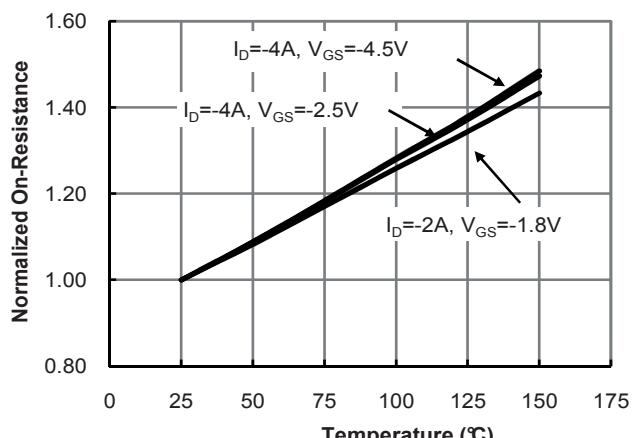


Figure 4: On-Resistance vs. Junction Temperature (Note E)

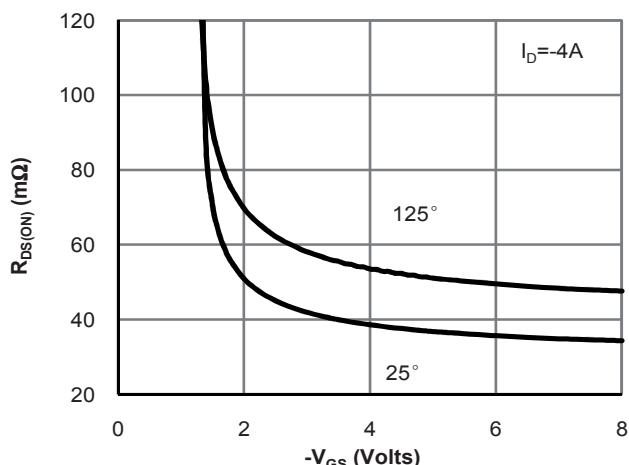


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

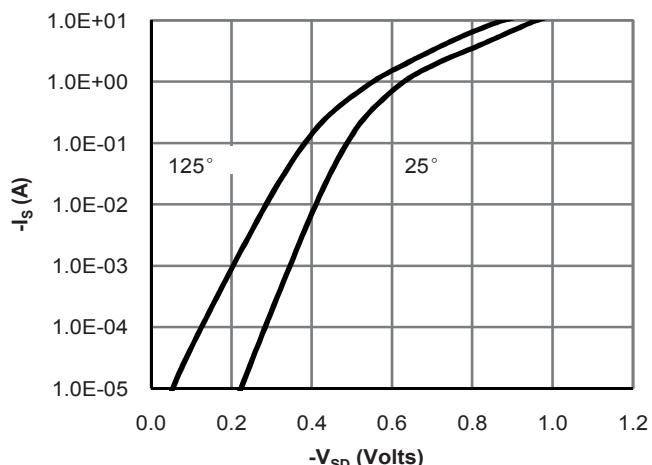


Figure 6: Body-Diode Characteristics (Note E)

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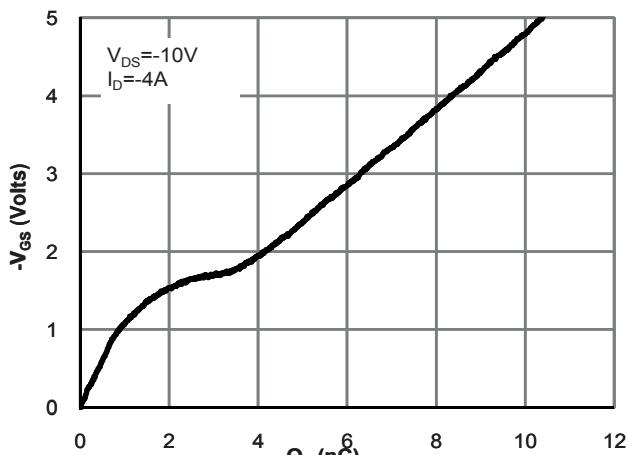


Figure 7: Gate-Charge Characteristics

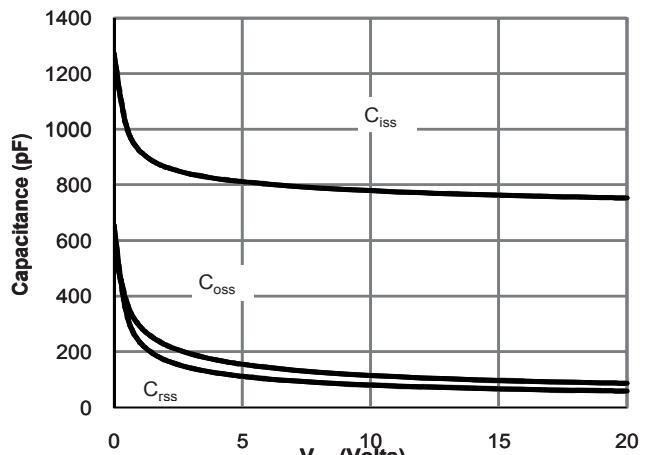


Figure 8: Capacitance Characteristics

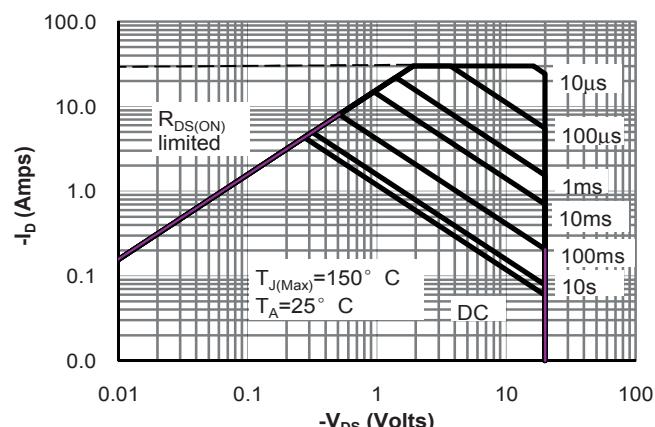


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

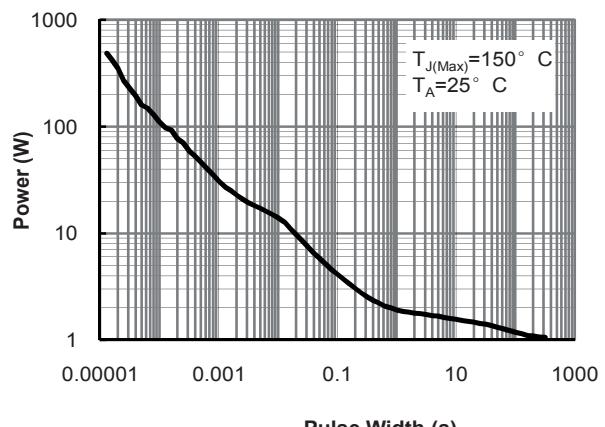


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

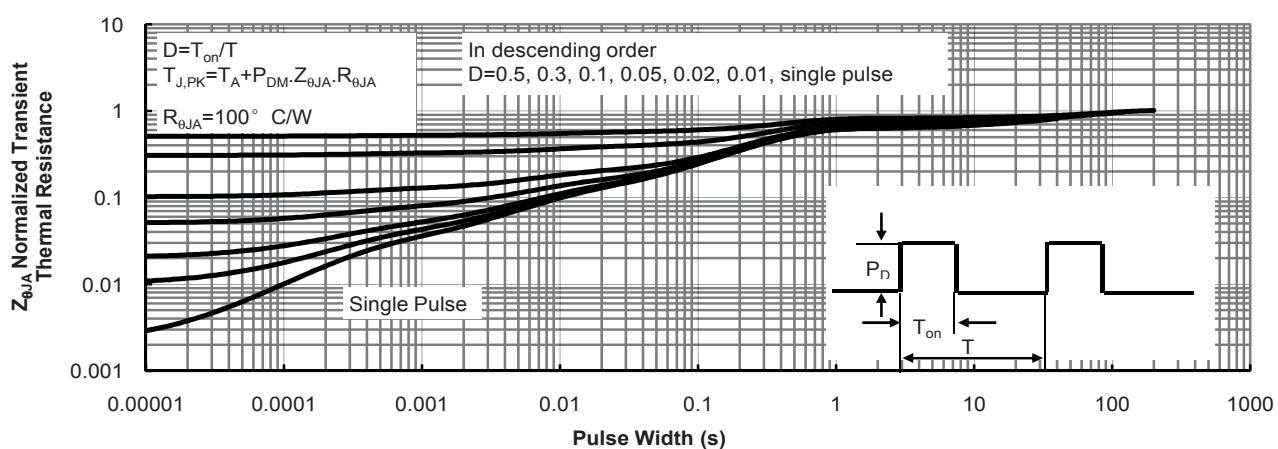


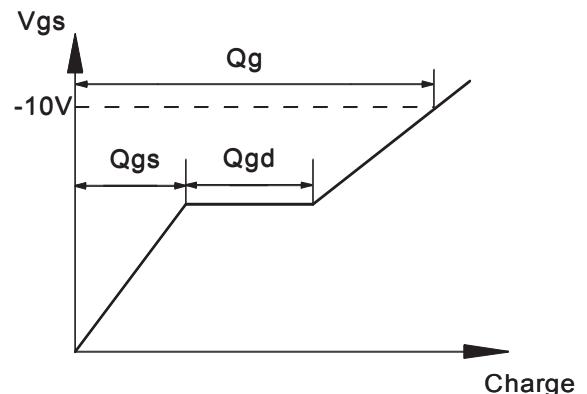
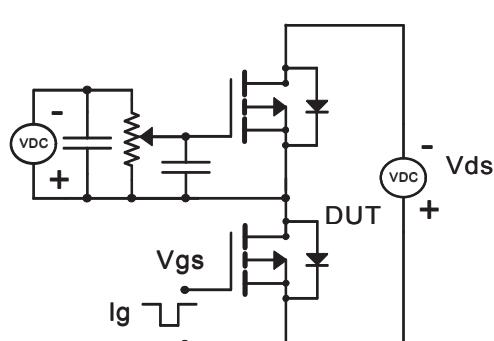
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

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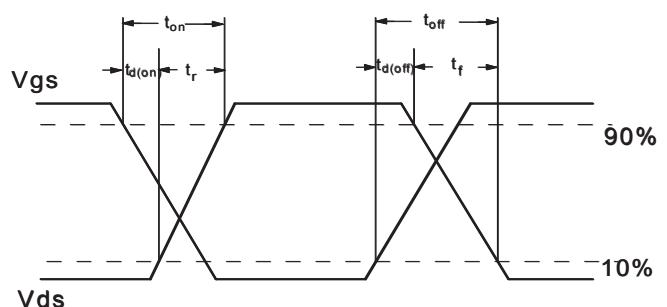
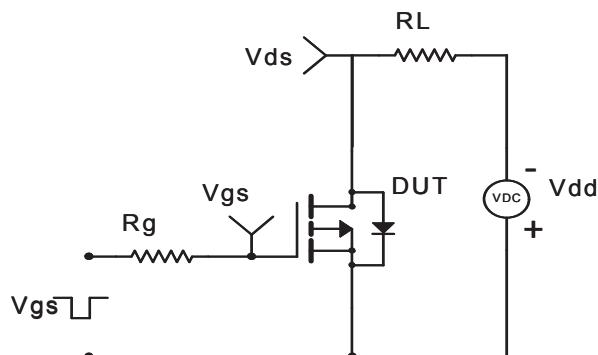
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■ Test circuit & waveform

Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

